



Part No	Pin	A	B	C	D
WAFER-HY2.0-2PLB	2	2.00	8.00	2.50	4.90
WAFER-HY2.0-3PLB	3	4.00	10.00	2.50	6.90
WAFER-HY2.0-4PLB	4	6.00	12.00	5.00	8.90
WAFER-HY2.0-5PLB	5	8.00	14.00	7.00	10.90
WAFER-HY2.0-6PLB	6	10.00	16.00	9.00	12.90
WAFER-HY2.0-7PLB	7	12.00	18.00	11.00	14.90
WAFER-HY2.0-8PLB	8	14.00	20.00	13.00	16.90
WAFER-HY2.0-9PLB	9	16.00	22.00	15.00	18.90
WAFER-HY2.0-10PLB	10	18.00	24.00	17.00	20.90
WAFER-HY2.0-11PLB	11	20.00	26.00	19.00	22.90
WAFER-HY2.0-12PLB	12	22.00	28.00	21.00	24.90
WAFER-HY2.0-13PLB	13	24.00	30.00	23.00	26.90
WAFER-HY2.0-14PLB	14	26.00	32.00	25.00	28.90
WAFER-HY2.0-15PLB	15	28.00	34.00	27.00	30.90
WAFER-HY2.0-16PLB	16	30.00	36.00	29.00	32.90

NOTES:

- 1.BASE: LCP
- 2.PIN: Brass
- 3.Solder Tab: Brass

SPECIFICATIONS:

- 1.Spacing: 2.0
- 2.Voltage Rating: 250V AC DC
- 3.Current Rating: 2A AC DC
- 4.Insulation Resistance: 800MΩ Min
- 5.Contact Resistance: 20mΩ Max
- 6.Withstanding voltage: 500V AC 1/Minute
- 7.Temperatuer Range: -25℃ ~+ 85℃

MANUFACTURE DWG			东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: WAFER 2.00 立贴带扣	
DECIMALS:	ANGLES:	PAR	WAFER-HY2.0-NPLB	
X.:±0.2	X'.:±5°	DWN		
.X:±0.1	X.X':±3°	CHKD		
.XX:±0.05	X.XX':±1°	APVD		
CUSTOMER COPY		SCALE1:1	UNIT:MM	
		SIZE:A4	SHEET:1F1	REV:A